

CBR06C419B5GAC

CBR-SMD RF COG, Ceramic, 4.1 pF, +/-0.1 pF, 50 VDC, COG, SMD, Fixed, RF, Ultra High Q, Low ESR, Class I, 0603



Click here for the 3D model.

| Dimensions | |
|------------|-----------------|
| Chip Size | 0603 |
| L | 1.6mm +/-0.1mm |
| W | 0.8mm +/-0.1mm |
| Т | 0.8mm +/-0.07mm |
| В | 0.4mm +/-0.15mm |

| Packaging Specifications | |
|--------------------------|--------------------------|
| Packaging | T&R, 180mm, Plastic Tape |
| Packaging Quantity | 4000 |

| General Information | |
|---------------------|------------------------------------------------|
| Series | CBR-SMD RF COG |
| Style | SMD Chip |
| Description | SMD, Fixed, RF, Ultra High Q, Low ESR, Class I |
| Features | Ultra High Q, Low ESR, Class I |
| RoHS | Yes |
| Termination | Tin |
| Marking | No |
| AEC-Q200 | No |
| Component Weight | 5.6 mg |
| Notes | Solder Wave or Solder Reflow. |
| Shelf Life | 78 Weeks |
| MSL | 1 |

| 4.1 pF |
|---------------------|
| +/-0.1pF |
| 50 VDC |
| 125 VDC |
| -55/+125°C |
| COG |
| 0.207% |
| 0% Loss/Decade Hour |
| 10 GOhms |
| 482 |
| |

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